2SK0664 (2SK664)

Silicon N-Channel MOS FET

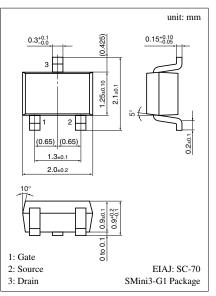
For switching

■ Features

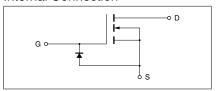
- High-speed switching
- S-mini type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing.

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit	
Drain to Source breakdown voltage	V _{DSS}	50	V	
Gate to Source voltage	V _{GSO}	8	V	
Drain current	I_D	100	mA	
Max drain current	I_{DP}	200	mA	
Allowable power dissipation	$P_{\rm D}$	150	mW	
Channel temperature	T _{ch}	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



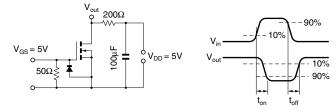
Marking Symbol: 3N Internal Connection



■ Electrical Characteristics (Ta = 25°C)

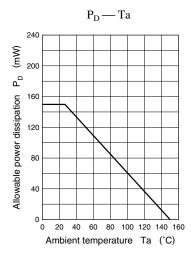
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I_{DSS}	$V_{DS} = 10V, V_{GS} = 0$			10	μA
Gate to Source leakage current	I_{GSS}	$V_{GS} = 8V, V_{DS} = 0$			50	μA
Drain to Source breakdown voltage	V _{DSS}	$I_D = 100 \mu A, V_{GS} = 0$	50			V
Gate threshold voltage	V _{th}	$I_D = 100\mu A, V_{DS} = V_{GS}$	1.5		3.5	V
Drain to Source ON-resistance	R _{DS(on)}	$I_D = 20 \text{mA}, V_{GS} = 5 \text{V}$			50	Ω
Forward transfer admittance	Y _{fs}	$I_D = 20 \text{mA}, V_{DS} = 5 \text{V}, f = 1 \text{kHz}$	20			mS
Input capacitance (Common Source)	C _{iss}				15	pF
Output capacitance (Common Source)	Coss	$V_{DS} = 5V, V_{GS} = 0, f = 1kHz$			5	pF
Reverse transfer capacitance (Common Source)	C _{rss}				1	pF
Turn-on time	t _{on} *	$V_{DD} = 5V, V_{GS} = 0 \text{ to } 5V, R_{L} = 200\Omega$		10		ns
Turn-off time	t _{off} *	$V_{DD} = 5V$, $V_{GS} = 5$ to $0V$, $R_L = 200\Omega$	· ·	20		ns

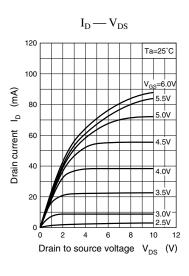
^{*} ton, toff measurement circuit

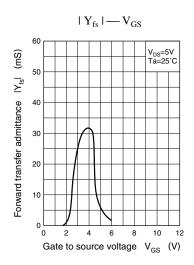


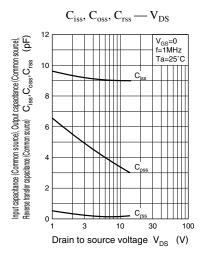
Note) The part number in the parenthesis shows conventional part number.

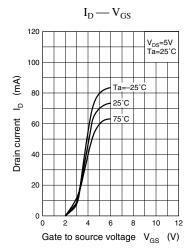
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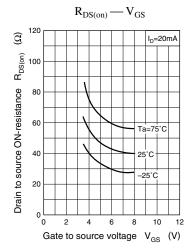


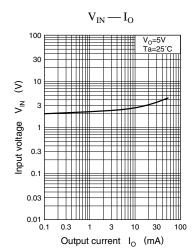












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